



Bi-Directional N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{S1S2} (V)	$R_{S1S2(on)}\left(\Omega\right)$	I _{S1S2} (A)		
30	0.045 at $V_{GS} = 4.5 \text{ V}$	4.9		
	0.060 at V _{GS} = 2.5 V	4.2		

FEATURES

- TrenchFET[®] Power MOSFET
- Ultra-Low $R_{SS(on)}$ and 22.5 $m\Omega$ Maximum Effective On-Resistance

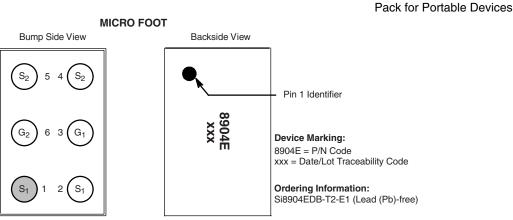


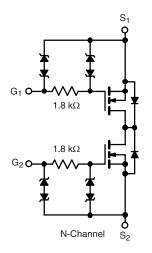
ROHS COMPLIANT

- ESD Protected: 4000 V
- MICRO FOOT[®] Chipscale Packaging Reduces Footprint Area, Profile (0.65 mm) and On-Resistance Per Footprint Area

APPLICATIONS

Battery Protection Circuit
1-2 Cell Li+/LiP Battery
Pack for Portable Devices





ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter	Symbol	5 s	Steady State	Unit		
Source1- Source2 Voltage		V_{S1S2}	30		V	
Gate-Source Voltage		V _{GS}	± 12			
Continuos Common Common /T 150 000	T _A = 25 °C	I	4.9	3.8		
Continuous Source1- Source2 Current (T _J = 150 °C) ^a	T _A = 85 °C	- I _{S1S2}	3.5	2.7	Α	
Pulsed Source1- Source2 Current		I _{SM}	25			
Mariana Barra Birata di ad	T _A = 25 °C	P _D 1.7 1		1	W	
Maximum Power Dissipation ^a	T _A = 85 °C	- FD	0.8	0.5	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Package Reflow Conditions ^c	IR/Convection		260		C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manigran Investiga to Against	t ≤ 5 s	R _{thJA}	60	75	°C/W
Maximum Junction-to-Ambient ^a	Steady State		95	120	
Maximum Junction-to-Foot ^b	Steady State	R_{thJF}	18	22	

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. The foot is defined as the top surface of the package.
- c. Refer to IPC/JEDEC (J-STD-020C), no manual or hand soldering.

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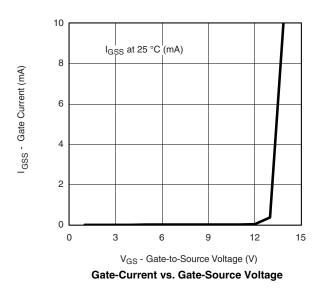
SPECIFICATIONS T _J = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Gate Threshold Voltage	$V_{GS(th)}$	$V_{SS} = V_{GS}, I_D = 250 \mu A$	0.6		1.6	>		
Cata Barbi Lashara	lana	$V_{SS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 4	μΑ		
Gate-Body Leakage	IGSS	$V_{SS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 10	mA		
Zara Cata Valtaga Cauraa Current	1	V _{SS} = 30 V, V _{GS} = 0 V			1	1 5 μΑ		
Zero Gate Voltage Source Current	I _{S1S2}	$V_{SS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			5			
On-State Source Current ^a	I _{S(on)}	$V_{SS} = 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	5			Α		
	В	V _{GS} = 4.5 V, I _{SS} = 1 A		0.037	0.045	0		
Source1- Source2 On-State Resistance ^a	a R _{S1S2(on)}	V _{GS} = 2.5 V, I _{SS} = 1 A		0.048	0.060	Ω		
Forward Transconductance ^a	9 _{fs}	V _{SS} = 10 V, I _{SS} = 1 A		12		S		
Dynamic ^b								
Turn-On Delay Time	t _{d(on)}			1.6	2.4			
Rise Time	t _r	V_{SS} = 10 V, R_L = 10 Ω		2	3			
Turn-Off Delay Time	t _{d(off)}	$I_{SS}\cong$ 1 A, V_{GEN} = 4.5 V, R_g = 6 Ω		1.5	2.3	μs		
Fall Time	t _f			3.7	5.6			

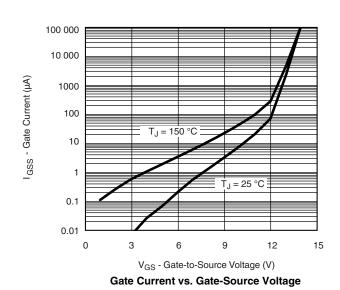
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



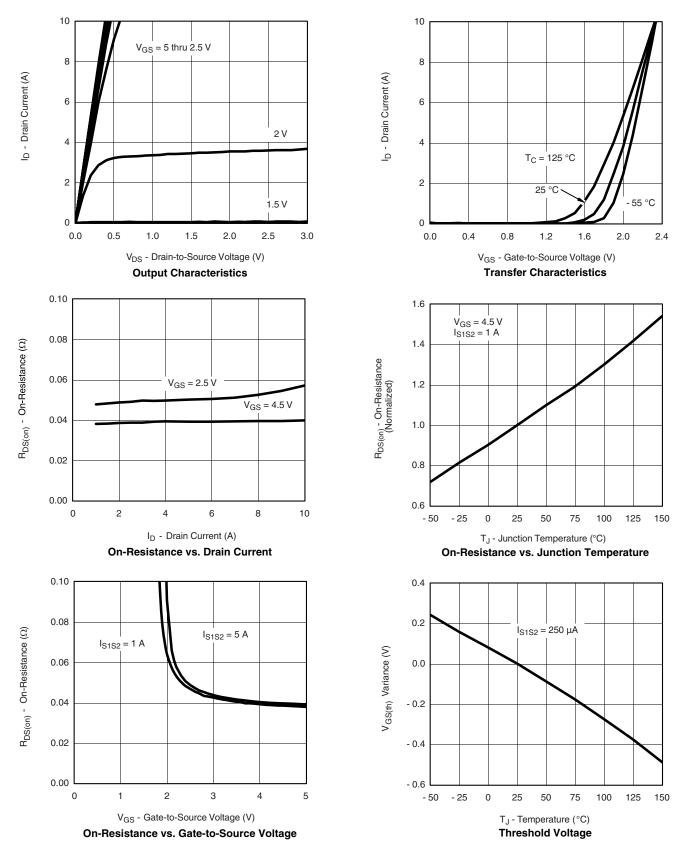








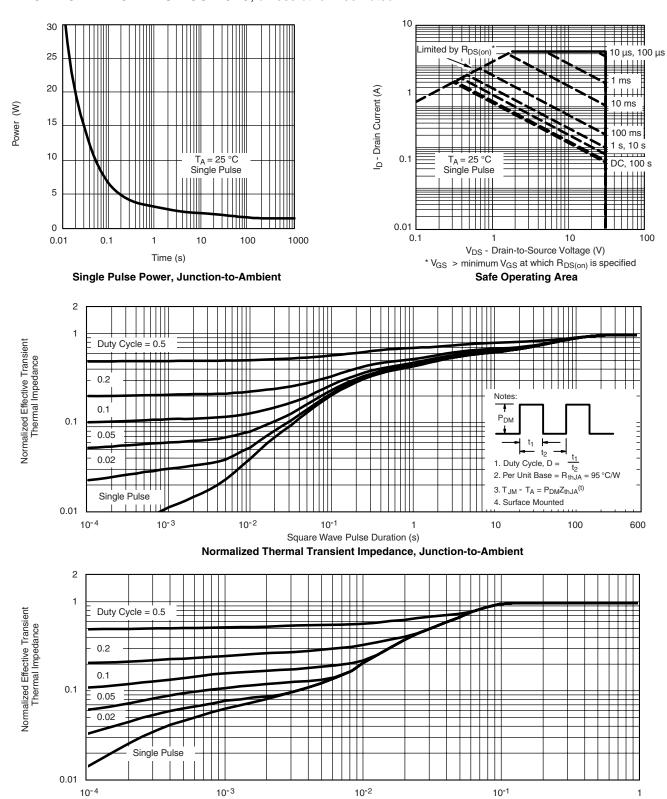
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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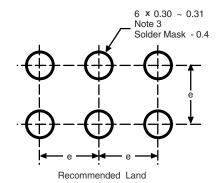
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

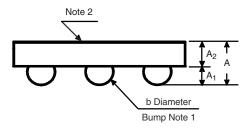




PACKAGE OUTLINE

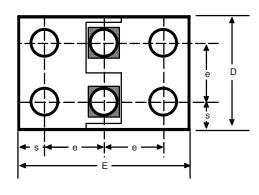
MICRO FOOT: 6-BUMP (2 x 3, 0.8 mm PITCH)







Mark on Backside of Die



Notes (Unless Otherwise Specified):

- 1. 6 solder bumps are 95.5/3.8/0.7 Sn/Ag/Cu.
- 2. Backside surface is coated with a Ag/Ni/Ti layer.
- 3. Non-solder mask defined copper landing pad.
- 4. Laser marks on the silicon die back.

Dim.	Millim	eters ^a	Inches		
	Min.	Max.	Min.	Max.	
Α	0.600	0.650	0.0236	0.0256	
A ₁	0.260	0.290	0.102	0.114	
A ₂	0.340	0.360	0.0134	0.0142	
b	0.370	0.410	0.0146	0.0161	
D	1.520	1.600	0.0598	0.0630	
E	2.320	2.400	0.0913	0.0945	
е	0.750	0.850	0.0295	0.0335	
s	0.380	0.400	0.0150	0.0157	

Notes:

a. Use millimeters as the primary measurement.

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